

## Call For Papers

Technologies for Measuring and Treating Stress and Trauma  
at the 57th Hawaii International Conference on System Sciences (HICSS)  
January 3-6, 2024 Hilton Hawaiian Village Resort, Waikiki Beach, Honolulu, HI.

### What is HICSS?

HICSS is the longest standing scientific conference in the information systems and technology field. Since 1968, it has attracted high caliber scholars and professionals in academia, industry, and government agencies around the world. Approximately half of attendees are from outside the US.

### Why submit my work here?

With the growing importance of technology in the delivery of healthcare, “Information Technology and Healthcare” is quickly becoming one of the largest areas of interest among HICSS attendees. It’s important to have the voices of medicine, behavioral medicine and the social sciences represented alongside technologists.

### Technologies for Measuring and Treating Stress and Trauma:

HICSS presentations cover 10 broad topic areas (tracks) each hosting multiple special interest mini-tracks. The “Technologies for Measuring and Treating Stress and Trauma” mini-track is seeking paper submissions for presentation at the 2023 conference. Each presentation session will consist of 3-4 paper presentations (~20-25 minutes each) leaving time for positive, collegial discussion.

### Paper Submission Details:

Conference submissions are not abstracts - they are fully developed papers that are peer reviewed. Authors of accepted papers have the opportunity to respond to reviews and edit their papers before publication in the conference journal. The conference is highly competitive with < 50% of submitted papers being accepted.

Contact mini-track co-chairs Daniel Roxbury, PhD ([roxbury@uri.edu](mailto:roxbury@uri.edu)), Nina Ayala, MD ([nina\\_ayala@brown.edu](mailto:nina_ayala@brown.edu)), or Beth Bock, PhD ([beth\\_bock@brown.edu](mailto:beth_bock@brown.edu)) for information about how to submit papers or check the HICSS website at <http://www.hicss.org/>

The manuscript submission deadline is June 15, 2023